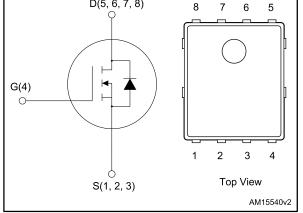


# Automotive-grade N-channel 40 V, 0.9 mΩ typ., 120 A STripFET™ F7 Power MOSFET in a PowerFLAT™ 5x6 package

 PowerFLAT™ 5x6

 Figure 1: Internal schematic diagram



Datasheet - production data

#### **Features**

Order code	VDS	R <sub>DS(on)</sub> max	ID
STL285N4F7AG	40 V	1.1 mΩ	120 A

- Designed for automotive applications and AEC-Q101 qualified
- Among the lowest R<sub>DS(on)</sub> on the market
- Excellent FoM (figure of merit)
- Low C<sub>rss</sub>/C<sub>iss</sub> ratio for EMI immunity
- High avalanche ruggedness
- Wettable flank package

### **Applications**

Switching applications

### Description

This N-channel Power MOSFET utilizes STripFET™ F7 technology with an enhanced trench gate structure that results in very low onstate resistance, while also reducing internal capacitance and gate charge for faster and more efficient switching.

#### Table 1: Device summary

Order code	Marking	Package	Packaging
STL285N4F7AG	285N4F7	PowerFLAT™ 5x6	Tape and reel

DocID028752 Rev 2

This is information on a product in full production.

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# 1 Electrical ratings

Table 2: Absolute maximum ratings

Symbol	Parameter	Value	Unit
V <sub>DS</sub>	Drain-source voltage	40	V
V <sub>GS</sub>	Gate-source voltage	± 20	V
I <sub>D</sub> <sup>(1)</sup>	Drain current (continuous) at T <sub>C</sub> = 25 °C	120	А
اD <sup>(1)</sup>	Drain current (continuous) at T <sub>C</sub> = 100 °C		А
IDM <sup>(1)(2)</sup>	Drain current (pulsed)	480	А
Ртот	Total dissipation at $T_c = 25 \text{ °C}$	188	W
IAV	Avalanche current, repetitive or not repetitive (pulse width limited by maximum junction temperature)		А
Eas	Single pulse avalanche energy (T <sub>j</sub> = 25 °C, $I_D$ = 24 A, $V_{DD}$ = 25 V)	280	mJ
Tj	Operating junction temperature range	-55 to	℃
T <sub>stg</sub>	Storage temperature range	175	

#### Notes:

 $^{(1)}\mbox{Drain current}$  is limited by package, the current capability of the silicon is 310 A at 25 °C.

<sup>(2)</sup>Pulse width limited by safe operating area

#### Table 3: Thermal data

Symbol	Parameter	Value	Unit
Rthj-pcb <sup>(1)</sup>	Thermal resistance junction-pcb max.	31.3	°C/W
Rthj-case	Thermal resistance junction-case max.	0.8	°C/W

#### Notes:

 $^{(1)}\!When$  mounted on FR-4 board of 1 inch², 2oz Cu, t < 10 s.



# 2 Electrical characteristics

(Tc = 25 °C unless otherwise specified)

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V(BR)DSS	Drain-source breakdown voltage	$V_{GS}$ = 0 V, $I_D$ = 250 $\mu$ A	40			V
I <sub>DSS</sub>	Zero gate voltage drain current	V <sub>GS</sub> = 0 V V <sub>DS</sub> = 40 V			1	μA
I <sub>GSS</sub>	Gate-body leakage current	$V_{GS}=20~V,~V_{DS}=0~V$			100	nA
V <sub>GS(th)</sub>	Gate threshold voltage	$V_{DS} = V_{GS}$ , $I_D = 250 \ \mu A$	2		4	V
R <sub>DS(on)</sub>	Static drain-source on-resistance	$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 24 \text{ A}$		0.9	1.1	mΩ

#### Table 4: On /off states

#### Table 5: Dynamic

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
Ciss	Input capacitance		-	5600	-	pF
Coss	Output capacitance	V <sub>DS</sub> = 25 V, f = 1 MHz, V <sub>GS</sub> = 0 V	-	2400	-	pF
Crss	Reverse transfer capacitance			35	-	pF
Qg	Total gate charge	$V_{DD} = 20 V, I_D = 48 A,$	-	67	-	nC
Qgs	Gate-source charge	$V_{GS} = 10 V$	-	31	-	nC
Q <sub>gd</sub>	Gate-drain charge	(see Figure 14: "Test circuit for gate charge behavior")	-	9	-	nC

#### Table 6: Switching times

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
t <sub>d(on)</sub>	Turn-on delay time	$V_{DD} = 20 \text{ V}, \text{ I}_{D} = 48 \text{ A},$	-	30	-	ns
tr	Rise time	$R_G$ = 4.7 $\Omega$ , $V_{GS}$ = 10 V	-	21	-	ns
t <sub>d(off)</sub>	Turn-off delay time	(see Figure 13: "Test circuit for resistive load	-	42	-	ns
t <sub>f</sub>	Fall time	switching times" and Figure 18: "Switching time waveform")	-	13	-	ns

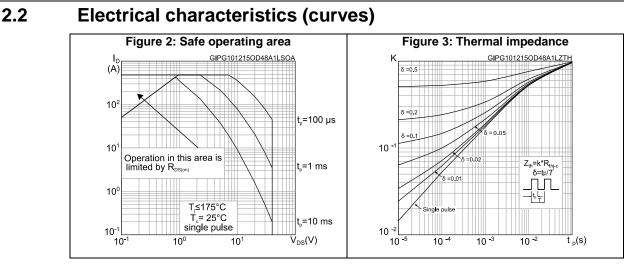
#### Electrical characteristics

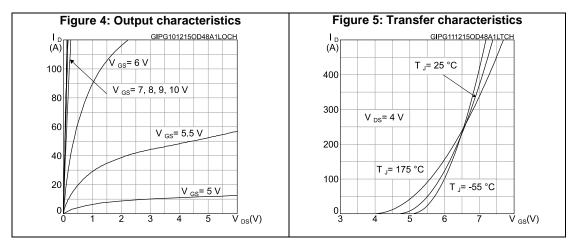
	Table 7: Source-drain diode					
Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V <sub>SD</sub> <sup>(1)</sup>	Forward on voltage	$I_{SD} = 48 \text{ A}, V_{GS} = 0 \text{ V}$	-		1.2	V
trr	Reverse recovery time	I <sub>D</sub> = 48 A, di/dt = 100 A/µs	-	68		ns
Qrr	Reverse recovery charge	V <sub>DD</sub> = 32 V	-	98		nC
Irrm	Reverse recovery current	(see Figure 15: "Test circuit for inductive load switching and diode recovery times")	-	2.9		A

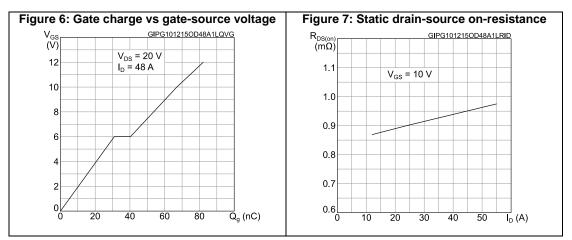
#### Notes:

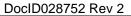
 $^{(1)}\text{Pulsed:}$  pulse duration = 300 µs, duty cycle 1.5%





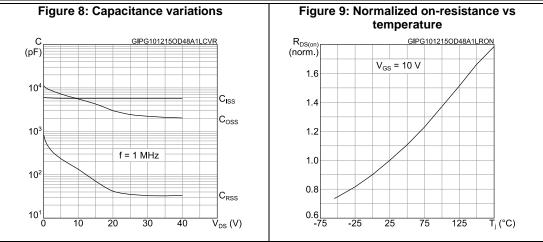


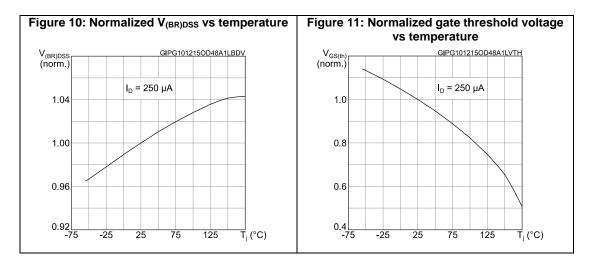


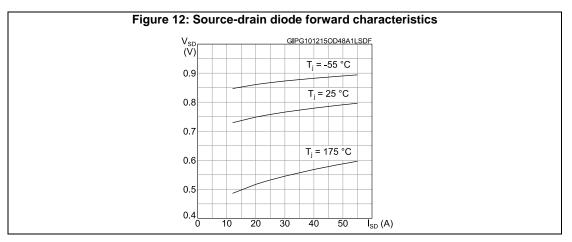




#### **Electrical characteristics**

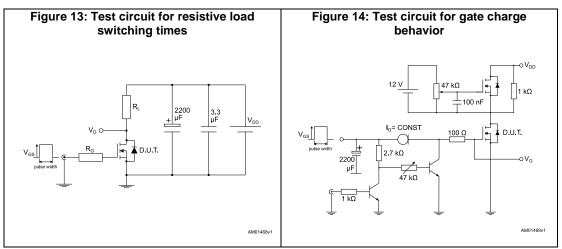


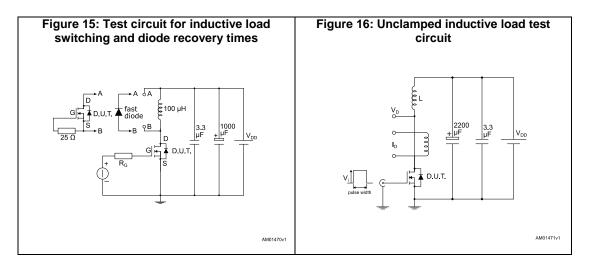


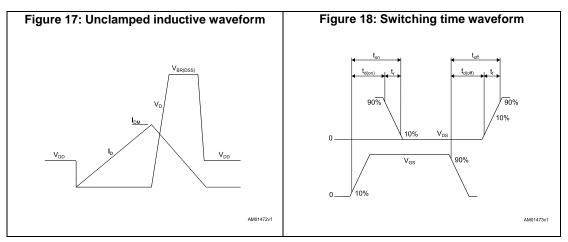


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### 3 Test circuits









### 4 Package mechanical data

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK<sup>®</sup> packages, depending on their level of environmental compliance. ECOPACK<sup>®</sup> specifications, grade definitions and product status are available at: *www.st.com*. ECOPACK<sup>®</sup> is an ST trademark.

### 4.1 PowerFLAT<sup>™</sup> 5x6 WF type C package information

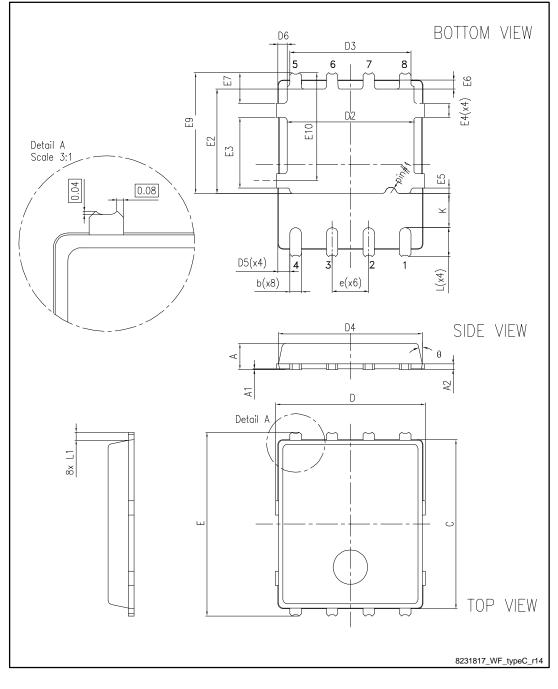


Figure 19: PowerFLAT™ 5x6 WF type C package outline



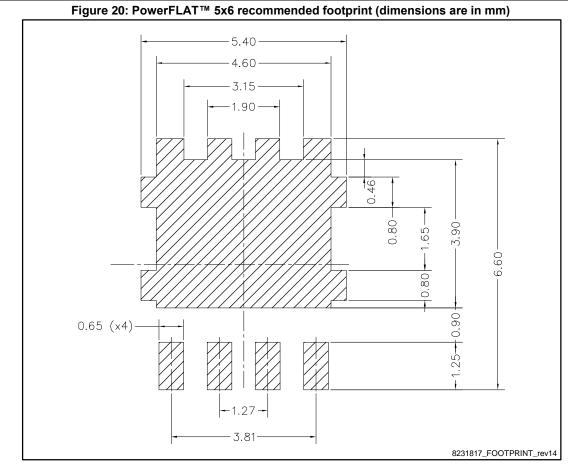
#### Package mechanical data

#### STL285N4F7AG

nechanical data	hanical data STL285N4F7AG				
Та	able 8: PowerFLAT™ 5x6	<b>3 WF type C mechanical</b>	data		
Dim		mm			
Dim.	Min.	Тур.	Max.		
A	0.80		1.00		
A1	0.02		0.05		
A2		0.25			
b	0.30		0.50		
С	5.80	6.00	6.10		
D	5.00	5.20	5.40		
D2	4.15		4.45		
D3	4.05	4.20	4.35		
D4	4.80	5.00	5.10		
D5	0.25	0.40	0.55		
D6	0.15	0.30	0.45		
е		1.27			
E	6.20	6.40	6.60		
E2	3.50		3.70		
E3	2.35		2.55		
E4	0.40		0.60		
E5	0.08		0.28		
E6	0.20	0.325	0.45		
E7	0.85	1.00	1.15		
E9	4.00	4.20	4.40		
E10	3.55	3.70	3.85		
К	1.05		1.35		
L	0.90	1.00	1.10		
L1	0.175	0.275	0.375		
θ	0°		12°		

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Package mechanical data



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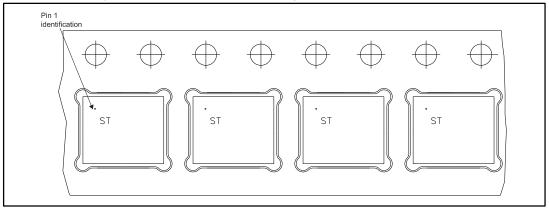
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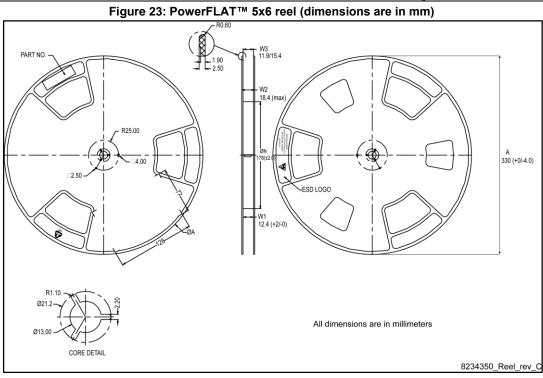
#### Figure 21: PowerFLAT™ 5x6 WF tape (dimensions are in mm) P2 2.0±0.05(l) Po 4.0±0.1(**II**) Do E1 1.75±0.1 Т Ø1.50 0.0 0.30±0.05 Y\_ $\oslash$ $\oplus$ $\bigcirc$ $\bigcirc$ $\oplus$ $\oplus$ $\bigcirc$ $\bigcirc$ F(5.50±0.0.05)(III) D1 Ø1.50MIN W(12.00±0.1) Bo (5.35±0.05) R0.30 MAX Ao(6.70±0.1) Ko (1.20±0.1) P1(8.00±0.1) SECTION Y-Y (I) Measured from centreline of sprocket hole to centreline of pocket. (II) Cumulative tolerance of 10 sprocket Base and bulk quatity 3000 pcs holes is ± 0.20. (III) Measured from centreline of sprocket hole to centreline of pocket. 8234350<u>T</u>apeWF<u>r</u>ev\_C

# 4.2 PowerFLAT<sup>™</sup> 5x6 packing information

Figure 22: PowerFLAT™ 5x6 package orientation in carrier tape









# 5 Revision history

Date	Revision	Changes
10-Dec-2015	1	First release.
09-Jun-2016	2	Modified: title Modified: <i>Table 4: "On /off states"</i> Updated: <i>Figure 7: "Static drain-source on-resistance"</i> Minor text changes

Table 9: Document revision history



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